

## MOSFET

## OptiMOS™ 6 Power-Transistor, 150 V

### **Features**

- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

## **Product validation**

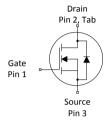
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key Performance Parameters

Parameter	Value	Unit
$V_{ m DS}$	150	V
$R_{\mathrm{DS(on),max}}$	2.9	mΩ
$I_{D}$	165	A
$Q_{\rm oss}$	310	nC
$Q_{G}$	105	nC
Q <sub>rr</sub> (500A/μs)	220	nC









Type/Ordering Code	Package	Marking	Related Links
IPB029N15NM6	PG-TO263-3	029N15N6	-

## Public

# OptiMOS™ 6 Power-Transistor, 150 V IPB029N15NM6



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# OptiMOS™ 6 Power-Transistor, 150 V IPB029N15NM6



# 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davameter	Cymahal		Values			Nata/Task Can dition	
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	165 126 126 24	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	660	А	T <sub>C</sub> =25 °C	
Avalanche current, single pulse <sup>4)</sup>	I <sub>AS</sub>	-	-	100	А	<i>T</i> <sub>c</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	1047	mJ	$I_{\rm D} = 58  \text{A},  R_{\rm GS} = 25  \Omega$	
Gate source voltage	$V_{GS}$	-20	-	20	V	-	
Power dissipation	$P_{\mathrm{tot}}$	-	-	395 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-	175	°C	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case	$R_{\mathrm{thJC}}$	-	-	0.38	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{thJA}$	-	-	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 6 Power-Transistor, 150 V IPB029N15NM6



# 3 Electrical characteristics

at  $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Limit	Note / Test Can dition	
raiailletei	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.5	4.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 276  \mu \text{A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	2.3 2.5 2.8	2.8 2.9 3.3	mΩ	$V_{GS}$ =15 V, $I_D$ =100 A $V_{GS}$ =10 V, $I_D$ =100 A $V_{GS}$ =8 V, $I_D$ =50 A	
Gate resistance	$R_{G}$	-	1.04	1.56	Ω	-	
Transconductance	$g_{fs}$	87	170	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=100 \text{ A}$	

Table 5 Dynamic characteristics

Daramatar	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min. Typ. Max.		Мах.	Unit	Note/ Test Condition	
Input capacitance <sup>6)</sup>	C <sub>iss</sub>	-	7600	9900	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, $f$ =1 MHz	
Output capacitance <sup>6)</sup>	C <sub>oss</sub>	-	2300	3000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Reverse transfer capacitance <sup>6)</sup>	C <sub>rss</sub>	-	25	38	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	22	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Rise time	t <sub>r</sub>	_	26	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Turn-off delay time	$t_{\sf d(off)}$	_	39	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Fall time	t <sub>f</sub>	_	24	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	

<sup>6)</sup> Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 7)

Parameter	Symbol	Values			Unit	Note/Test Condition	
raiailietei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Gate to source charge <sup>8)</sup>	$Q_{ m gs}$	-	41	53	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	26	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge <sup>8)</sup>	$Q_{ m gd}$	-	23	35	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	$Q_{sw}$	-	37	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>8)</sup>	$Q_{\mathrm{g}}$	-	105	137	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	$Q_{g(sync)}$	-	89	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V	
Output charge <sup>8)</sup>	$Q_{ m oss}$	-	310	403	nC	V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V	

 $<sup>^{7)}\ \ \,</sup>$  See "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

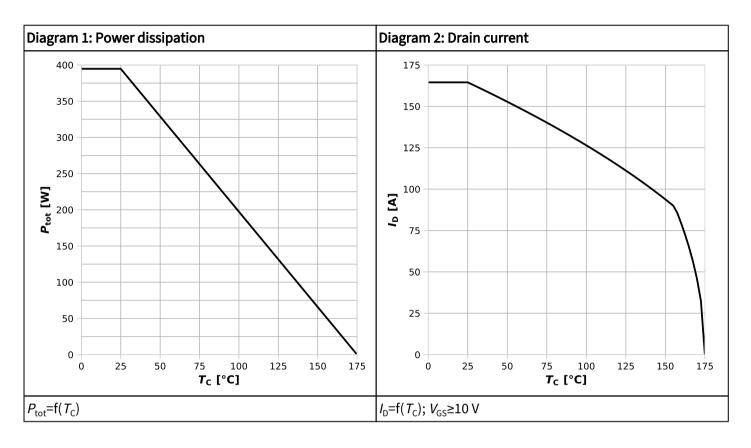
Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Diode continuous forward current	Is	-	-	151	А	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	660	А	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	$V_{\rm SD}$	-	0.89	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C
Reverse recovery time <sup>9)</sup>	t <sub>rr</sub>	-	44	88	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d $t$ =500 A/ $\mu$ s
Reverse recovery charge <sup>9)</sup>	$Q_{\rm rr}$	-	220	440	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d $t$ =500 A/ $\mu$ s
Reverse recovery time <sup>9)</sup>	t <sub>rr</sub>	-	40	80	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d $t$ =1000 A/ $\mu$ s
Reverse recovery charge <sup>9)</sup>	$Q_{\rm rr}$	-	410	820	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d $t$ =1000 A/ $\mu$ s

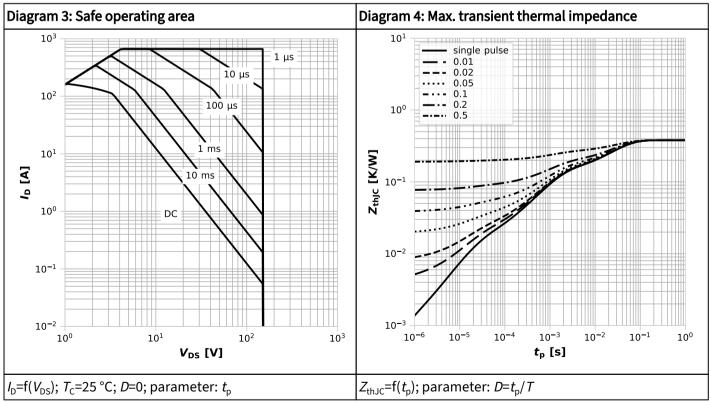
<sup>9)</sup> Defined by design. Not subject to production test.

<sup>8)</sup> Defined by design. Not subject to production test.

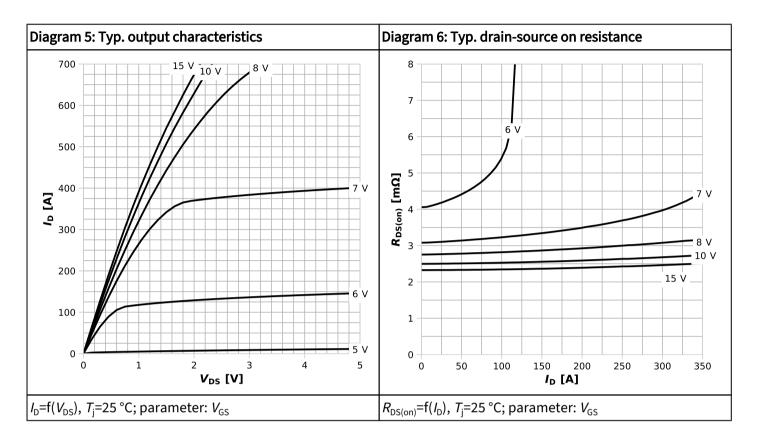


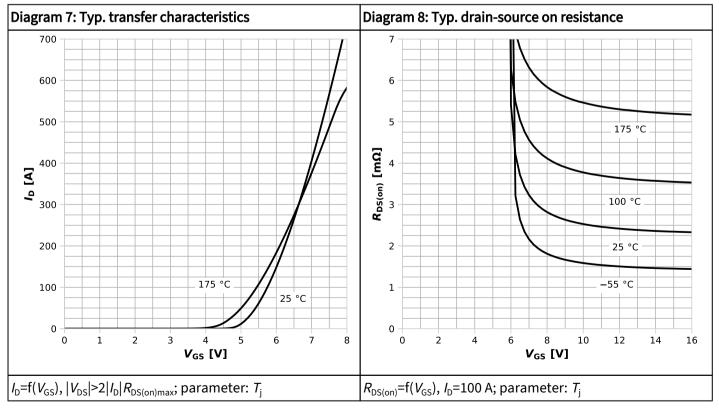
# 4 Electrical characteristics diagrams



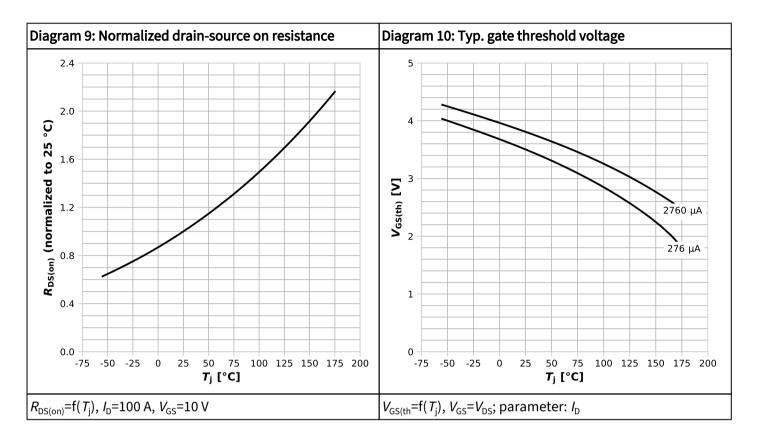


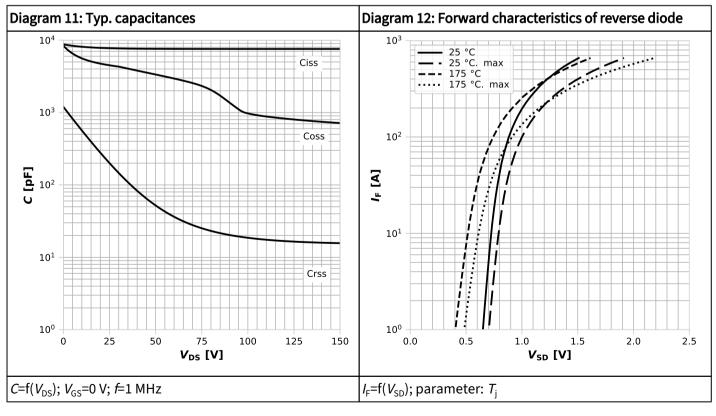




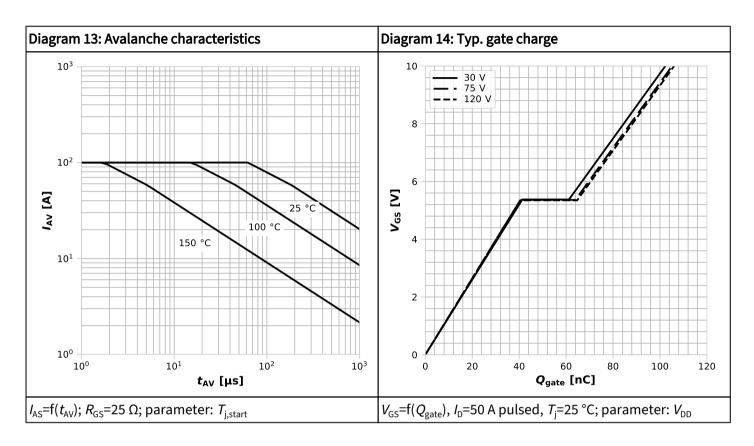


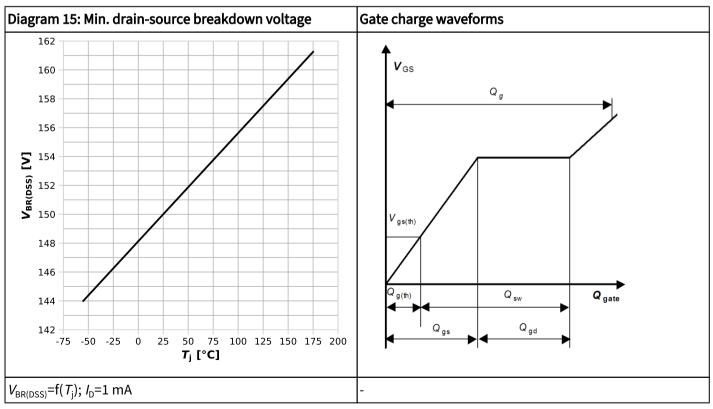






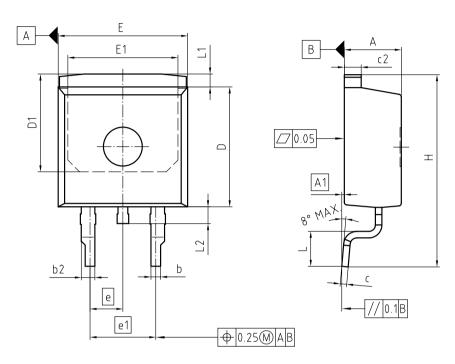








# 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TO2	PG-TO263-3-U01						
DIMENSIONS	MILLIMETERS							
DIMENSIONS	MIN.	MAX.						
Α	4.30	4.50						
A1	0.00	0.10						
b	0.65	0.85						
b2	0.95	1.15						
С	0.40	0.60						
c2	1.17	1.37						
D	9.05	9.45						
D1	7.45	7.65						
E	9.80	10.20						
E1	8.40	8.60						
е	2.	.54						
e1	5.08							
N		2						
Н	14.60	15.90						
L	2.40	3.00						
L1	0.70	1.30						
L2	1.00	1.60						

Figure 1 Outline PG-TO263-3, dimensions in mm

# OptiMOS™ 6 Power-Transistor, 150 V IPB029N15NM6



### **Revision History**

IPB029N15NM6

#### Revision 2024-04-22, Rev. 2.0

**Previous Revision** 

Revision	Date	Subjects (major changes since last revision)
1.0	2024-03-15	Release of preliminary version
2.0	2024-04-22	Release of final

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